| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $\mathrm{~V}_{\mathrm{P}}$ |
| Load Current | 120 | mA |
| Max $\mathrm{R}_{\mathrm{ON}}$ | 35 | $\Omega$ |

## Features

- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- $3750 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount Tape \& Reel Packages Available


## Applications

- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- Ground Start
- Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls


## Description

LAA110 is a Dual 1-Form-A Solid State Relay that has two independently controlled optically coupled MOSFET switches. The MOSFET switches and photovoltaic die use Clare's patented OptoMOS ${ }^{\circledR}$ architecture to provide $3750 \mathrm{~V}_{\text {rms }}$ of input to output isolation. The optically coupled output is controlled by a highly efficient GaAIAs infrared LED. This dual pole OptoMOS relay provides a more compact design solution than discrete single-pole relays in a variety of applications and saves board space by incorporating both switches in a single 8-Pin package.

## Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- EN/IEC 60950-1:2001 Compliant


## Ordering Information

| Part \# | Description |
| :--- | :--- |
| LAA110 | 8-Pin DIP (50/Tube) |
| LAA110S | 8-Pin Surface Mount (50/Tube) |
| LAA110STR | 8-Pin Surface Mount (1,000/Reel) |
| LAA110P | 8-Pin Flat Pack (50/Tube) |
| LAA110PTR | 8-Pin Flat Pack (1,000/Reel) |

## Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices


## Absolute Maximum Ratings

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $\mathrm{~V}_{\mathrm{p}}$ |
| Reverse Input Voltage | 5 | V |
| Input Control Current <br> Peak (10ms) | 50 | mA |
| Input Power Dissipation ${ }^{1}$ | 1 | A |
| Total Power Dissipation ${ }^{2}$ | 800 | mW |
| Isolation Voltage, Input to Output | 3750 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate Linearly $1.33 \mathrm{mw} /{ }^{\circ} \mathrm{C}$
${ }^{2}$ Derate Linearly $6.67 \mathrm{mw} /{ }^{\circ} \mathrm{C}$
Electrical absolute maximum ratings are at $25^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

## Electrical Characteristics

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics @ $25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| Load Current, Continuous ${ }^{1}$ | - | $I_{L}$ | - | - | 120 | mA |
| Peak Load Current | $\mathrm{t}=10 \mathrm{~ms}$ | $\mathrm{I}_{\text {LPK }}$ | - | - | 350 | mA |
| On-Resistance | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $\mathrm{R}_{\text {ON }}$ | - | 25 | 35 | $\Omega$ |
| Off-State Leakage Current | $\mathrm{V}_{\mathrm{L}}=350 \mathrm{~V}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Switching Speeds Turn-On | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{T}_{\text {ON }}$ | - | - | 3 | ms |
| Turn-Off | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{T}_{\text {OFF }}$ | - | - | 3 | ms |
| Output Capacitance | 50V; f=1MHz | $\mathrm{C}_{\text {OUT }}$ | - | 25 | - | pF |
| Input Characteristics @ 25 ${ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| Input Control Current | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $I_{\text {F }}$ | - | - | 5 | mA |
| Input Dropout Current | - | - | 0.4 | 0.7 | - | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics @ $25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| Input to Output Capacitance | - | $\mathrm{C}_{1 / 0}$ | - | 3 | - | pF |

${ }^{1}$ If both poles operate the load current must be derated so as not to exceed the package power dissipation value.

## PERFORMANCE DATA*


*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## PERFORMANCE DATA*

LAA110


LAA110
Typical On-resistance vs. Temperature


LAA110
Typical $I_{F}$ for Switch Dropout vs. Temperature (Load Current $=50 \mathrm{~mA}_{\mathrm{DC}}$ )


LAA110


LAA110
Typical On-resistance vs. Temperature


LAA110
Typical Load Current vs. Load Voltage (Ambient Temperature $=25^{\circ} \mathrm{C}$ )


LAA110
Typical Turn-Off vs. LED Forward Current (Load Current $=50 \mathrm{~mA}_{\mathrm{DC}}$ )


LAA110
Typical I for Switch Operation vs. Temperature (Load Current $=50 \mathrm{~mA}_{\mathrm{DC}}$ )


LAA110


LAA110

## Manufacturing Information

## Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

## Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

Recommended soldering processes are limited to $260^{\circ} \mathrm{C}$ component body temperature for 10 seconds.


MECHANICAL DIMENSIONS

## 8-Pin DIP Through Hole (Standard)



PC Board Pattern (Top View)


## MECHANICAL DIMENSIONS

## Tape and Reel Packaging for 8-Pin Surface Mount Package



NOTE: Tape dimensions not shown, comply with JEDEC Standard EIA-481-2

## Tape and Reel Packaging for 8-Pin Flatpack Package



NOTE: Tape dimensions not shown, comply with JEDEC Standard EIA-481-2

## For additional information please visit our website at: www.clare.com

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